



SPN125T10

N-Channel Enhancement Mode MOSFET

DESCRIPTION

The SPN125T10 is the N-Channel enhancement mode power field effect transistor which is produced using super high cell density DMOS trench technology. This high density process is especially tailored to minimize on-state resistance. These devices are particularly suitable for synchronous rectifier application, Motor control power management and other Power Tool circuits. It has been optimized for low gate charge, low $R_{DS(ON)}$ and fast switching speed.

APPLICATIONS

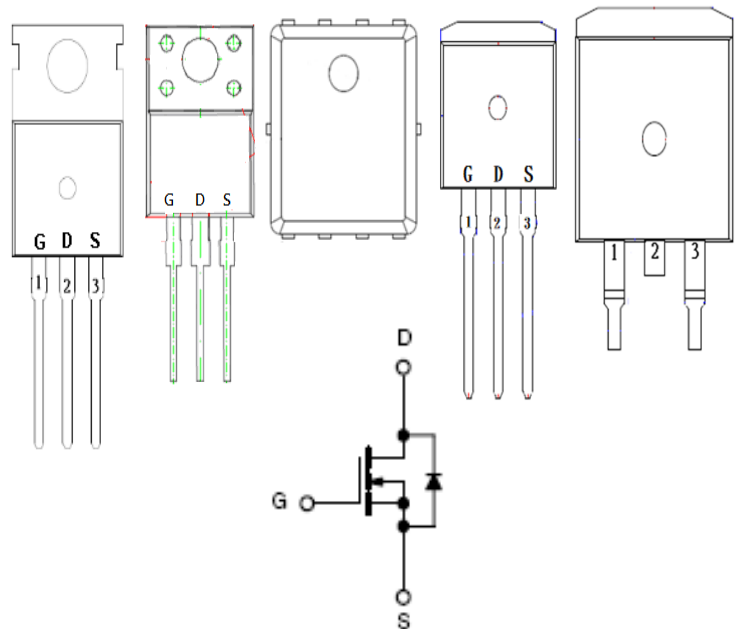
- DC/DC Converter
- Load Switch
- SMPS Secondary Side Synchronous Rectifier
- Motor Control
- Power Tool

FEATURES

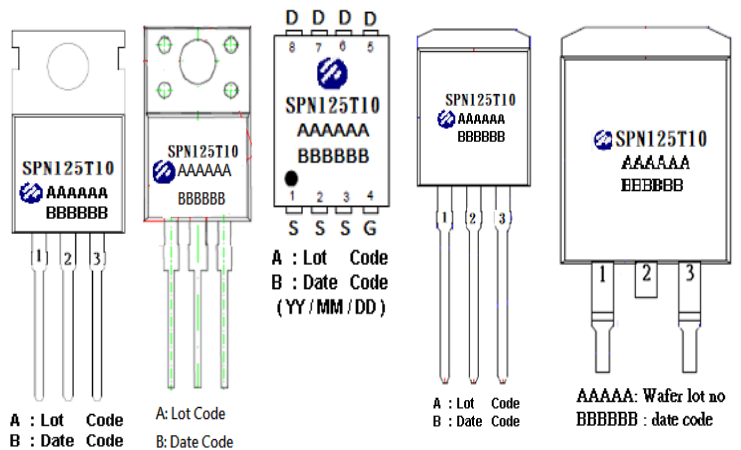
- ◆ 100V/112A, $R_{DS(ON)}=4.2m\Omega@V_{GS}=10V$
- ◆ Super high density cell design for extremely low $R_{DS(ON)}$
- ◆ Exceptional on-resistance and maximum DC current capability
- ◆ TO-220-3L/TO-220F-3L/PPAK5x6-8L/TO-262-3L/TO-263-2L package design

PIN CONFIGURATION

TO-220 TO-220F PPAK5x6 TO-262 TO-263



PART MARKING





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TO-220-3L/TO-220F-3L/TO-262-3L/TO-263-2L PIN DESCRIPTION

Pin	Symbol	Description
1	G	Gate
2	D	Drain
3	S	Source

PPAK5x6-8L PIN DESCRIPTION

Pin	Symbol	Description
1	S	Source
2	S	Source
3	S	Source
4	G	Gate
5	D	Drain
6	D	Drain
7	D	Drain
8	D	Drain

ORDERING INFORMATION

Part Number	Package	Part Marking
SPN125T10T220TGB	TO-220-3L	SPN125T10
SPN125T10T220FTGB	TO-220F-3L	SPN125T10
SPN125T10T263TGB	TO-262-3L	SPN125T10
SPN125T10DN8RGB	PPAK5x6-8L	SPN125T10
SPN125T10T262RGB	TO-263-2L	SPN125T10

- ※ SPN125T10T220TGB : Tube ; Pb – Free ; Halogen – Free
- ※ SPN125T10T220FTGB : Tube ; Pb – Free ; Halogen – Free
- ※ SPN125T10T263TGB : Tube ; Pb – Free ; Halogen – Free
- ※ SPN125T10DN8RGB : Tape&Reel ; Pb – Free ; Halogen – Free
- ※ SPN125T10T262RGB : Tape&Reel ; Pb – Free ; Halogen - Free



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ABSOLUTE MAXIMUM RATINGS

(TA=25°C Unless otherwise noted)

Parameter	Symbol	Typical	Unit	
Drain-Source Voltage	V _{DSS}	100	V	
Gate-Source Voltage	V _{GSS}	±20	V	
Continuous Drain Current (Silicon Limited) (TO-220/TO-220F/TO-262)	I _D	T _C =25°C	161	A
		T _C =100°C	114	
Continuous Drain Current (Silicon Limited) (PPAK5x6)	I _D	T _C =25°C	112	A
		T _C =100°C	60	
Pulsed Drain Current	I _{DM}	400	A	
Power Dissipation (T _C =25°C)	TO-220/TO-262/TO-263	P _D	104	W
Power Dissipation (T _C =25°C)	TO-220F	P _D	93	W
Power Dissipation (T _C =25°C)	PPAK5x6	P _D	83	W
Avalanche Energy with Single Pulse (T _j =25°C, L=0.1mH)	E _{AS}	180	mJ	
Operating Junction Temperature	T _J	-55/150	°C	
Storage Temperature Range	T _{STG}	-55/150	°C	
Thermal Resistance-Junction to Case (TO-220/TO-220F/TO-262)	R _{θJC}	1.2	°C/W	
Thermal Resistance-Junction to Case (PPAK5x6)	R _{θJC}	1.5	°C/W	
Thermal Resistance-Junction to Ambient (TO-220/TO-220F/TO-262)	R _{θJA}	60	°C/W	
Thermal Resistance-Junction to Ambient (PPAK5x6)	R _{θJA}	50	°C/W	

Note :

The maximum current rating is package limited at 130A for TO-262-3L and TO-263-2L

The maximum current rating is package limited at 120A for TO-220-3L

The maximum current rating is package limited at 78A for TO-220F-3L

The maximum current rating is package limited at 80A for PPAK5x6-8L



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ELECTRICAL CHARACTERISTICS

(TA=25°C Unless otherwise noted)

Parameter	Symbol	Conditions	Min.	Typ	Max.	Unit
Static						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS}=0V, I_D=250\mu A$	100			V
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=250\mu A$	2	3	4	
Gate Leakage Current	I_{GSS}	$V_{DS}=0V, V_{GS}=\pm 20V$			± 100	nA
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS}=80V, V_{GS}=0V$ $T_J=25^\circ C$			1	uA
		$V_{DS}=80V, V_{GS}=0V$ $T_J=100^\circ C$			100	
Drain-Source On-Resistance (TO-220, TO-262, PPAK5x6)	$R_{DS(on)}$	$V_{GS}=10V, I_D=20A$			4.2	mΩ
Drain-Source On-Resistance (TO-220F)	$R_{DS(on)}$	$V_{GS}=10V, I_D=20A$			4.8	mΩ
Forward Transconductance	g_{fs}	$V_{DS}=5V, I_D=20A$		50		S
Gate Resistance	R_G	$V_{GS}=0V, V_{DS}$ open, $f=1MHz$		1.3		Ω
Diode Forward Voltage	V_{SD}	$I_S=20A, V_{GS}=0V$		0.9	1.2	V
Dynamic						
Total Gate Charge (10V)	Q_g	$V_{DS}=50V, V_{GS}=10V$ $I_D=20A$		75		nC
Gate-Source Charge	Q_{gs}			10		
Gate-Drain Charge	Q_{gd}			34		
Input Capacitance	C_{iss}	$V_{DS}=50V, V_{GS}=0V$ $f=1MHz$		3650		pF
Output Capacitance	C_{oss}			1110		
Reverse Transfer Capacitance	C_{rss}			43		
Turn-On Time	$t_{d(on)}$	$V_{DD}=50V, I_D=20A$ $V_{GS}=10V, R_G=10\Omega$		13		nS
	t_r			19		
Turn-Off Time	$t_{d(off)}$			45		
	t_f			27		
Reverse Recovery Time	t_{rr}	$V_R=50V, I_F=20A, d$		50		nS
Reverse Recovery Charge	Q_{rr}	$I_F/dt=500A/uS$		275		nC



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TYPICAL CHARACTERISTICS

Fig 1. Typical Output Characteristics

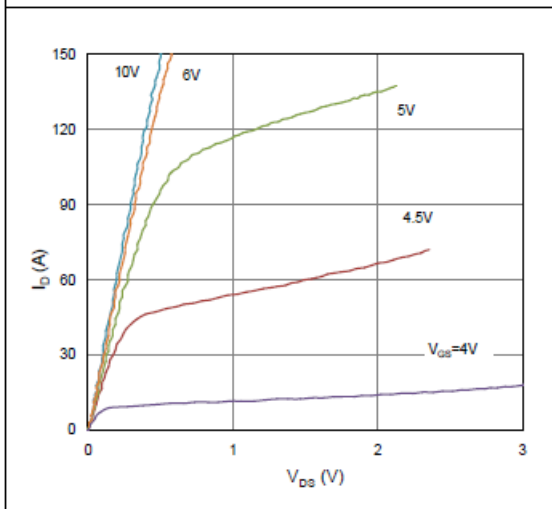


Figure 2. On-Resistance vs. Gate-Source Voltage

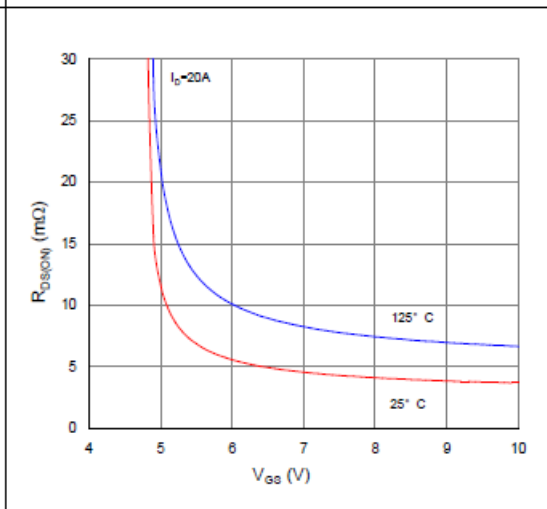


Figure 3. On-Resistance vs. Drain Current and Gate Voltage

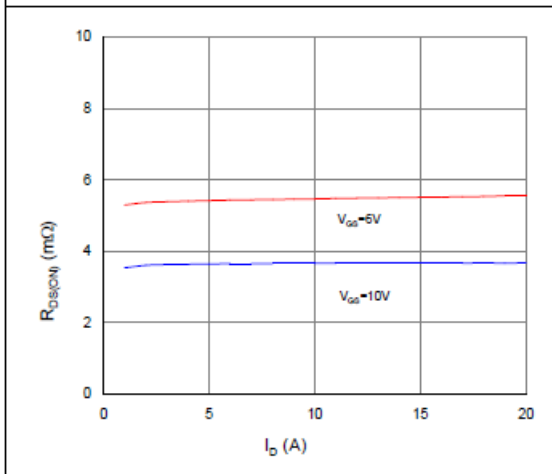


Figure 4. Normalized On-Resistance vs. Junction Temperature

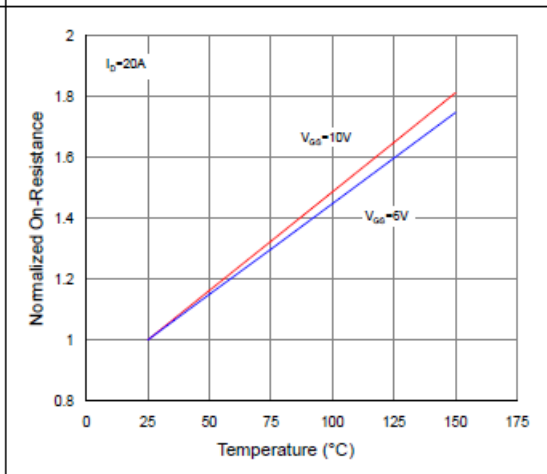


Figure 5. Typical Transfer Characteristics

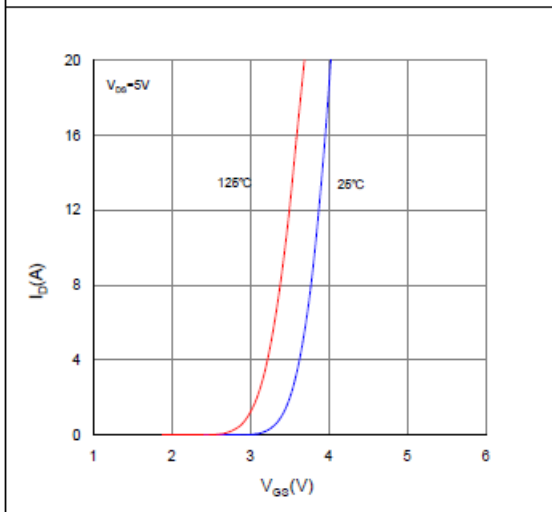
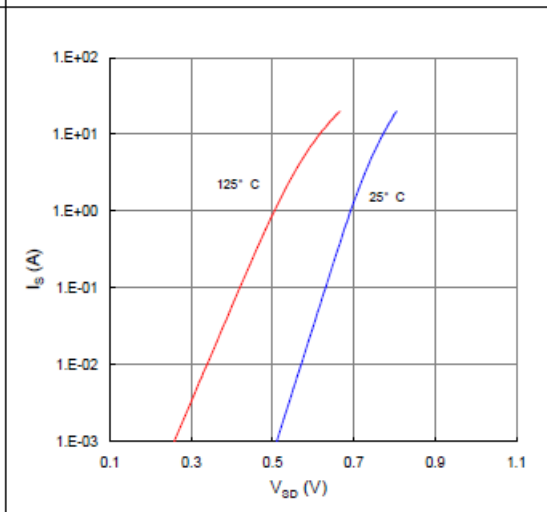


Figure 6. Typical Source-Drain Diode Forward Voltage





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TYPICAL CHARACTERISTICS

Figure 7. Typical Gate-Charge vs. Gate-to-Source Voltage

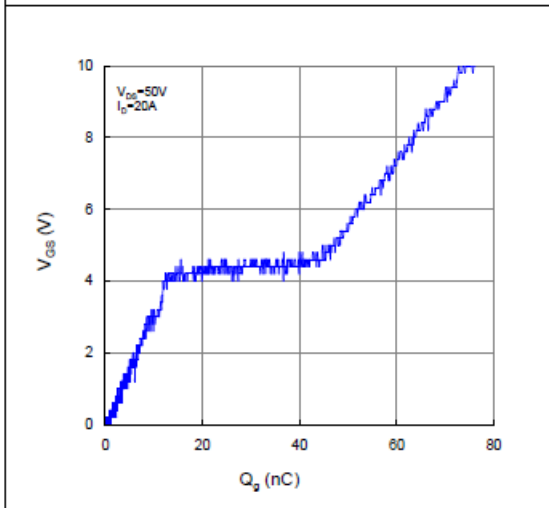


Figure 8. Typical Capacitance vs. Drain-to-Source Voltage

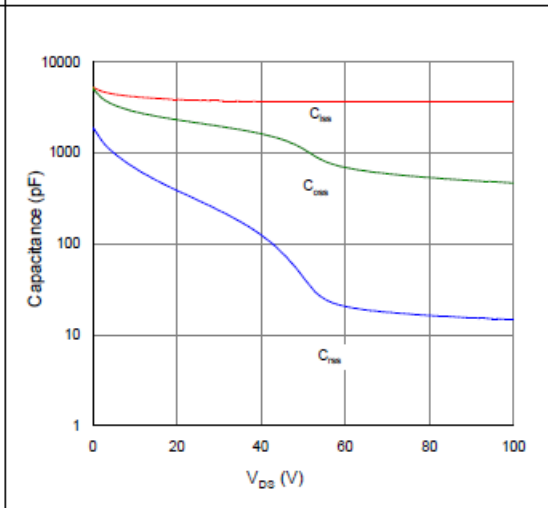


Figure 9. Maximum Safe Operating Area

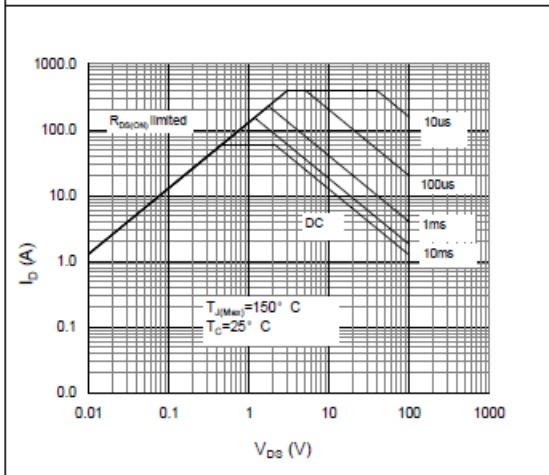


Figure 10. Maximum Drain Current vs. Case Temperature

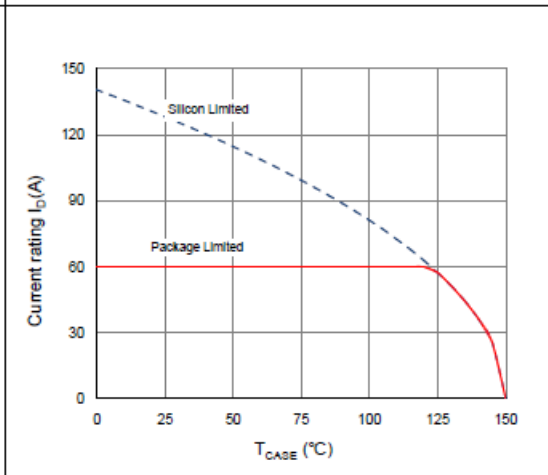
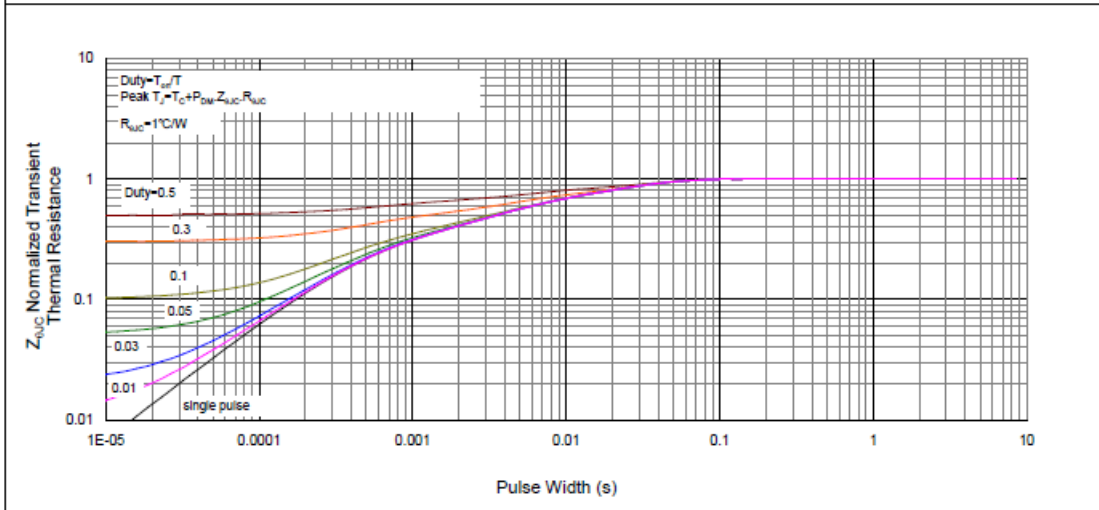


Figure 11. Normalized Maximum Transient Thermal Impedance, Junction-to-Case





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SYNC Power Corporation

7F-2, No.3-1, Park Street

NanKang District (NKSP), Taipei, Taiwan 115

Phone: 886-2-2655-8178

Fax: 886-2-2655-8468

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